Unit: mm

TOSHIBA INSULATED GATE BIPOLAR TRANSISTOR SILICON N CHANNEL IGBT

GT60M303

HIGH POWER SWITCHING APPLICATIONS

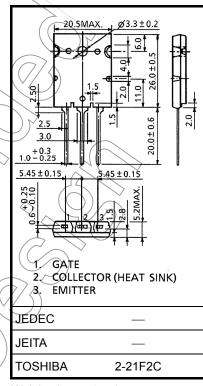
- Fourth generation IGBT
- FRD included between emitter and collector
- Enhancement mode type
- High speed I_{GBT} : $t_f = 0.25 \mu s$ (TYP.)

FRD : $t_{rr} = 0.7 \mu s$ (TYP.)

• Low saturation voltage : $V_{CE (sat)} = 2.1V (TYP.)$

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C) CHARACTERISTIC SYMBOL RATIN

CHARACTERISTIC		SYMBOL	RATING	(UNIT)	
Collector-Emitter Voltage		V _{CES}	900	V	
Gate-Emitter Voltage		V _{GES}	±25	V	
Collector Current	DC	IC	60	Α	
	1ms	I _{CP}	120		
Emitter-Collector Foward Current	DC	IECF	15	A	
	1ms	IECFP	120		
Collector Power Dissipation (Tc = 25°C)		PC	170	W	
Junction Temperature		T ₁	150	√ °C	
Storage Temperature Range		(T _{stg})	-55~150	<i></i> //%c	
Screw Torque	(77/_	0.8	N-m	

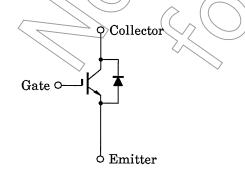


Weight: 9.75 g (typ.)

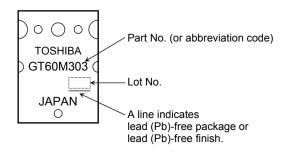
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

EQUIVALENT CIRCUIT

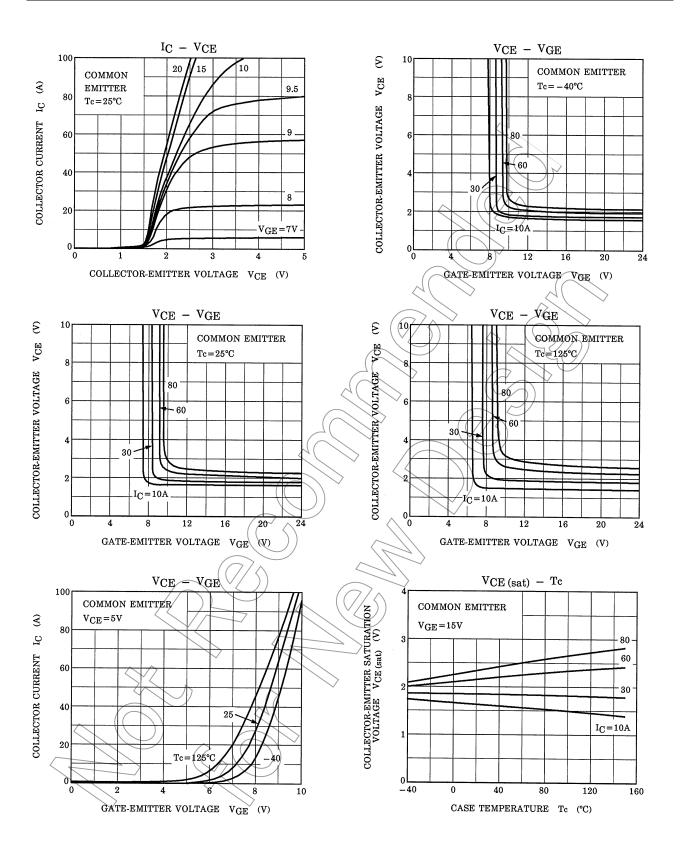


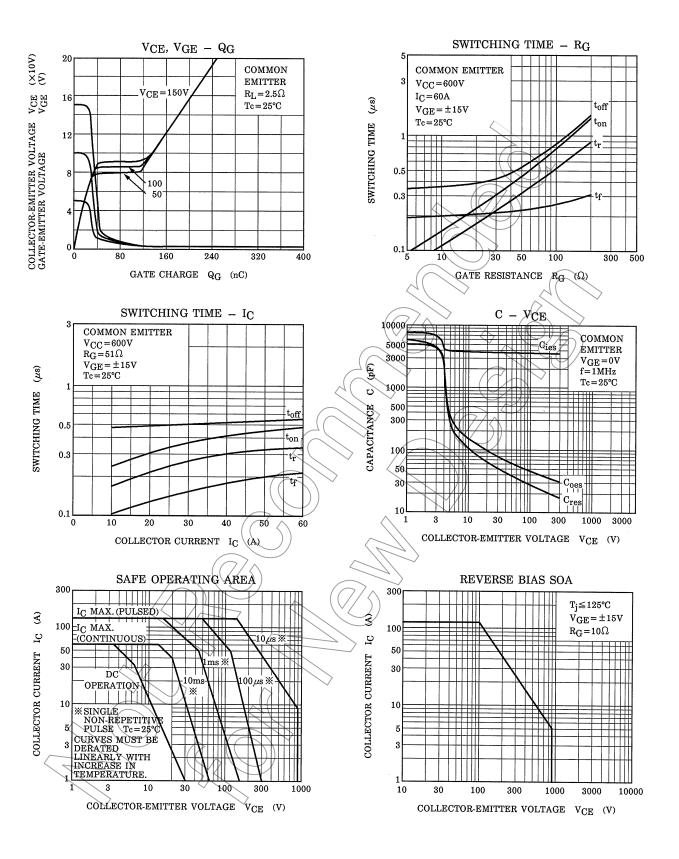
MARKING

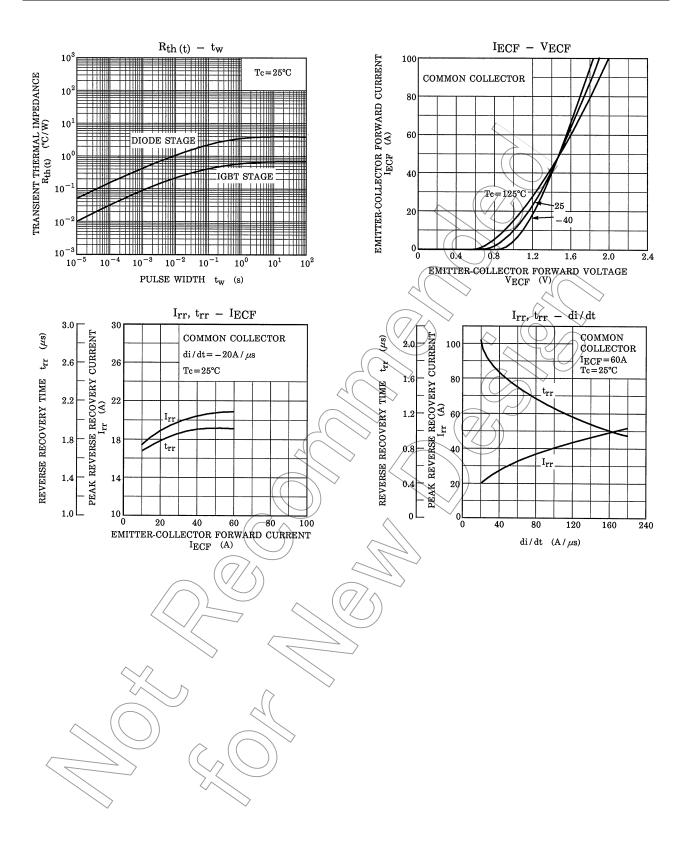


ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Gate Leakage Curr	ent	I _{GES}	V _{GE} = ±25V, V _{CE} = 0	_	_	±500	nA
Collector Cut-off C	urrent	I _{CES}	V _{CE} = 900V, V _{GE} = 0	_	_	1.0	mA
Gate-Emitter Cut-o	off Voltage	V _{GE} (OFF)	I _C = 60mA, V _{CE} = 5V	3.0	_	6.0	V
Collector-Emitter S	aturation Voltage	V _{CE} (sat) (1)	I _C = 10A, V _{GE} = 15V		1.6	2.2	V
Collector-Emitter S	aturation Voltage	V _{CE} (sat) (2)	I _C = 60A, V _{GE} = 15V		2.1	2.7	V
Input Capacitance		C _{ies}	V _{CE} = 10V, V _{GE} = 0, f = 1MHz) > 	3800	_	pF
Switching Time	Rise Time	t _r	15V 51Ω C C C C C C C C C C C C C C C C C C C	$\bigcirc))$	0.35	0.60	5 0 μs
	Turn-On Time	t _{on}		_	0.46	0.75	
	Fall Time	t _f		_	0.25	0.40	
	Turn-Off Time	t _{off}		_	0.60	0.70	
Emitter-Collector Fo	orward Voltage	V _{ECF}	I _{EC} = 15A, V _{GE} = 0		<1.5	2.0	V
Reverse Recovery	Time	t _{rr}	I _F = 15A, V _{GE} = 0 di / dt = -20A / µs	(0.7	2.5	μs
Thermal Resistance F		R _{th (j-c)}	IGBT	()	(4)	0.74	°C / W
Thermal Resistance		R _{th (j-c)}	Diode	\\ -\	>=	4.0	°C/W









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20070701-EN

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